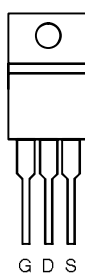


**SUP/SUB75N05-06A***New Product***Vishay Siliconix****N-Channel 50-V (D-S), 175°C MOSFET****PRODUCT SUMMARY**

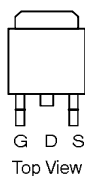
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A)
50	0.006	75

**TO-220AB**

Top View

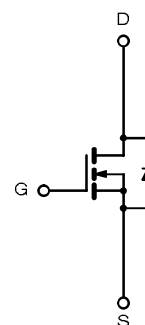
Ordering Information: SUP75N05-06A

DRAIN connected to TAB

**TO-263**

Top View

Ordering Information: SUB75N05-06A



N-Channel MOSFET

**ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

Parameter		Symbol	Limit	Unit
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current ( $T_J = 175^\circ\text{C}$ )	$T_C = 25^\circ\text{C}$	$I_D$	75 <sup>a</sup>	A
	$T_C = 125^\circ\text{C}$		70	
Pulsed Drain Current		$I_{DM}$	240	
Avalanche Current		$I_{AR}$	75	
Repetitive Avalanche Energy <sup>b</sup>		$E_{AR}$	280	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$ (TO-220AB and TO-263)	$P_D$	250 <sup>c</sup>	W
	$T_A = 25^\circ\text{C}$ (TO-263) <sup>d</sup>		3.7	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to 175	$^\circ\text{C}$

**THERMAL RESISTANCE RATINGS**

Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) <sup>d</sup>	$R_{thJA}$	40	$^\circ\text{C/W}$
	Free Air (TO-220AB)		62.5	
Junction-to-Case		$R_{thJC}$	0.6	

**Notes**

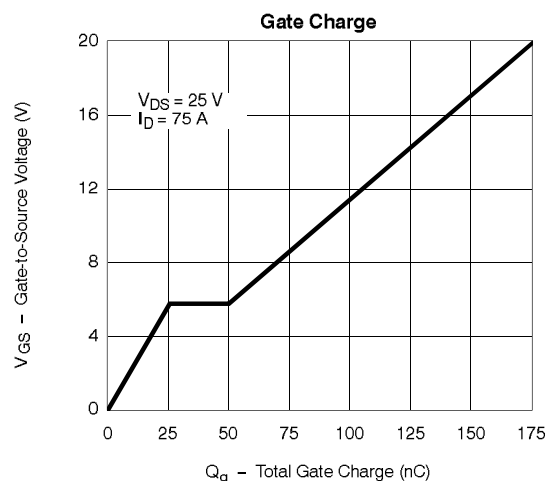
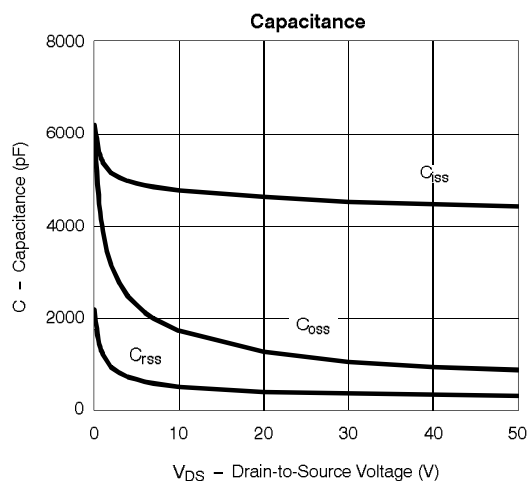
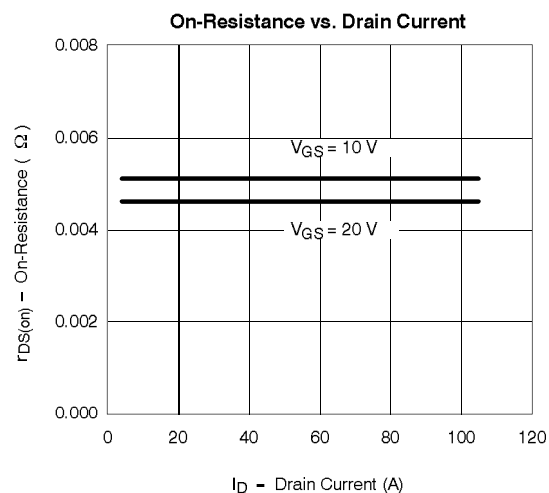
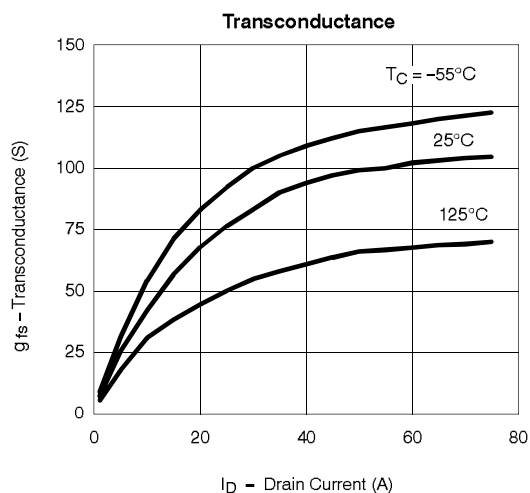
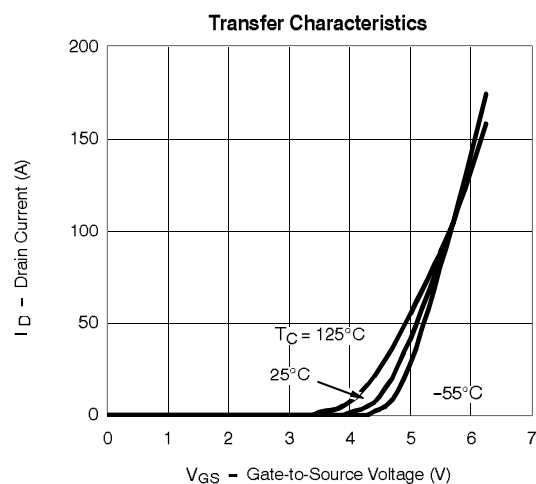
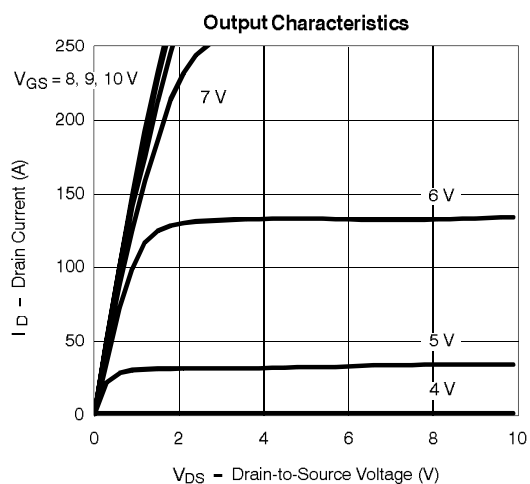
- Package limited.
- Duty cycle  $\leq 1\%$ .
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

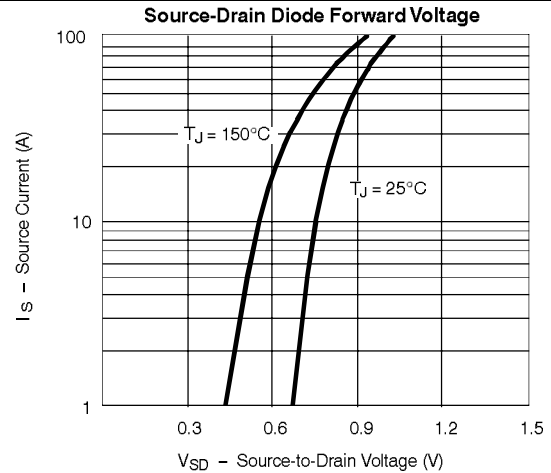
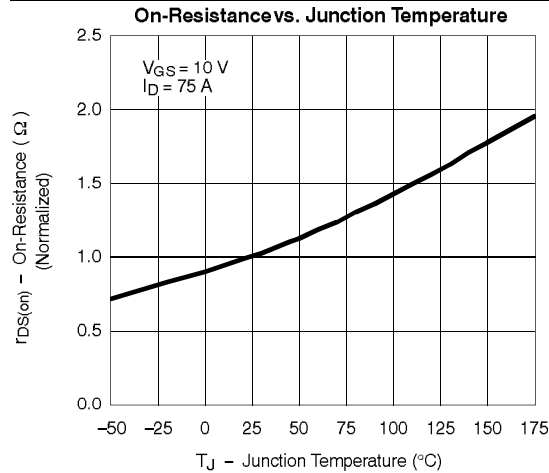


SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	50			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0		4.0	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V			1	μA
		V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C			50	
		V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175°C			150	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	120			A
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A		0.005	0.006	Ω
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A, T <sub>J</sub> = 125°C			0.010	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A, T <sub>J</sub> = 175°C			0.012	
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 60 A	30			S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz		4500		pF
Output Capacitance	C <sub>oss</sub>			1100		
Reverse Transfer Capacitance	C <sub>rss</sub>			360		
Total Gate Charge <sup>c</sup>	Q <sub>g</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 75 A		85	120	nC
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>			25		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			25		
Gate Resistance	R <sub>g</sub>	f = 1.0 MHz		3		Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>	V <sub>DD</sub> = 25 V, R <sub>L</sub> = 0.33 Ω I <sub>D</sub> ≅ 75 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 2.5 Ω		20	40	ns
Rise Time <sup>c</sup>	t <sub>r</sub>			20	100	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			50	100	
Fall Time <sup>c</sup>	t <sub>f</sub>			20	40	
Source-Drain Diode Ratings and Characteristics (T <sub>C</sub> = 25°C) <sup>b</sup>						
Continuous Current	I <sub>S</sub>				75	A
Pulsed Current	I <sub>SM</sub>				200	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 75 A , V <sub>GS</sub> = 0 V		1.0	1.4	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 75 A, di/dt = 100 A/μs		65	120	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>			5	8	A
Reverse Recovery Charge	Q <sub>rr</sub>			0.16	0.48	μC

## Notes

- a. Pulse test: pulse width  $\leq 300\text{ }\mu\text{sec}$ , duty cycle  $\leq 2\%$ .  
b. Guaranteed by design, not subject to production testing.  
c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)****THERMAL RATINGS**